

SPECIFICATION

DEVICE NAME : Power MOSFET

TYPE NAME : 2SJ476-01L,S

SPEC. NO. :

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

	DATE	NAME	APPROVED		Fuji Electric Co.,Ltd.	
DRAWN					DWG. NO.	1/13
CHECKED						

1.Scope This specifies Fuji Power MOSFET 2SJ476-01L,S

2.Construction P-Channel enhancement mode power MOSFET

3.Applications for Switching

4.Outview T-Pack L-Type : Outview See to 5/13 page
S-Type : Outview See to 6/13 page

5.Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V_{DS}	-60	V	
Continuous Drain Current	I_D	± 25	A	
Pulsed Drain Current	I_{DP}	± 100	A	
Gate-Source Voltage	V_{GS}	± 20	V	
Maximum Avalanche Energy	E_{AV}	325.9	mJ	*1
Maximum Power Dissipation	P_D	50	W	
Operating and Storage	T_{ch}	150	°C	
Temperature range	T_{stg}	-55 to +150	°C	

*1 L=0.695mH, Vcc=-24V

6.Electrical Characteristics at Tc=25°C (unless otherwise specified)

Static Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = -1mA$ $V_{GS} = 0V$	-60			V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D = -1mA$ $V_{DS} = V_{GS}$	-1.0	-1.5	-2.5	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -60V$ $V_{GS} = 0V$	$T_{ch} = 25^\circ C$ $T_{ch} = 125^\circ C$	-10 -0.2	-500 -1.0	μA mA
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 20V$ $V_{DS} = 0V$		10	100	nA
Drain-Source On-State Resistance	$R_{DS(on)}$	$I_D = -12.5A$ $V_{GS} = -4V$ $V_{GS} = -10V$		80 45	110 60	$m\Omega$

Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g_{fs}	$I_D = -12.5A$ $V_{DS} = -25V$	7.5	15.0		S
Input Capacitance	C_{iss}	$V_{DS} = -25V$ $V_{GS} = 0V$ $f = 1MHz$		2000	3000	pF
Output Capacitance	C_{oss}			700	1050	
Reverse Transfer Capacitance	C_{rss}			450	680	
Turn-On Time	$t_d(on)$	$V_{cc} = -30V$		15	25	ns
	t_r	$V_{GS} = -10V$		80	120	
Turn-Off Time	$t_d(off)$	$I_D = -25A$		190	290	
	t_f	$R_{GS} = 10\Omega$		90	140	

Reverse Diode

Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	I_{AV}	$L = 100\mu H$ $T_{ch} = 25^\circ C$ See Fig.1 and Fig.2	-25			A
Diode Forward On-Voltage	V_{SD}	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V$ $T_{ch} = 25^\circ C$		-2	-3	V
Reverse Recovery Time	t_{rr}	$I_F = I_{DR}$ $di/dt = 100A/\mu s$ $T_{ch} = 25^\circ C$		160		ns
Reverse Recovery Charge	Q_{rr}			0.9		μC

7. Thermal Resistance

Description	Symbol	min.	typ.	max.	Unit
Channel to Case	$R_{th(ch-c)}$			2.50	$^\circ C/W$
Channel to Ambient	$R_{th(ch-a)}$			75	$^\circ C/W$

Fig.1 Test circuit

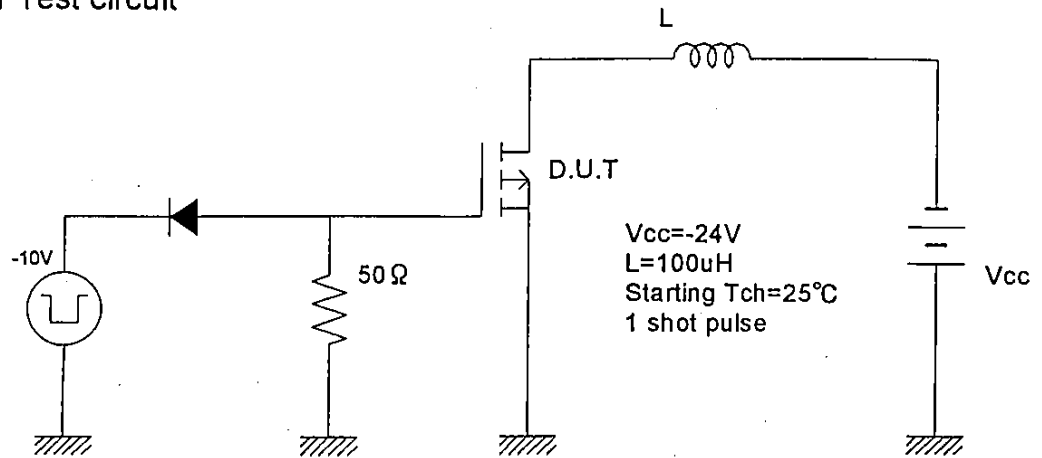
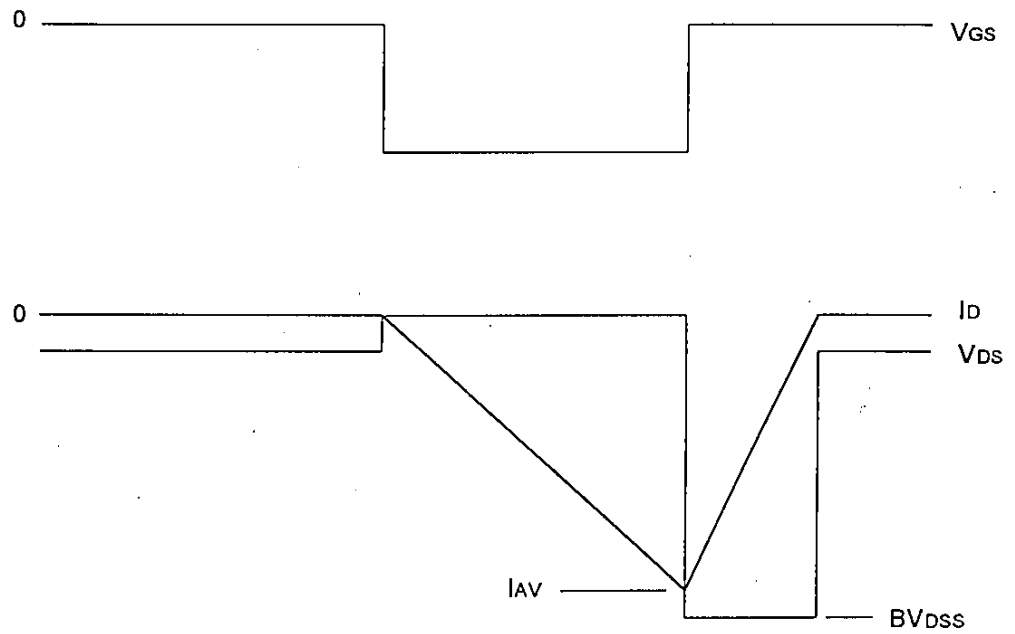
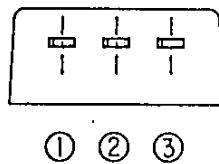
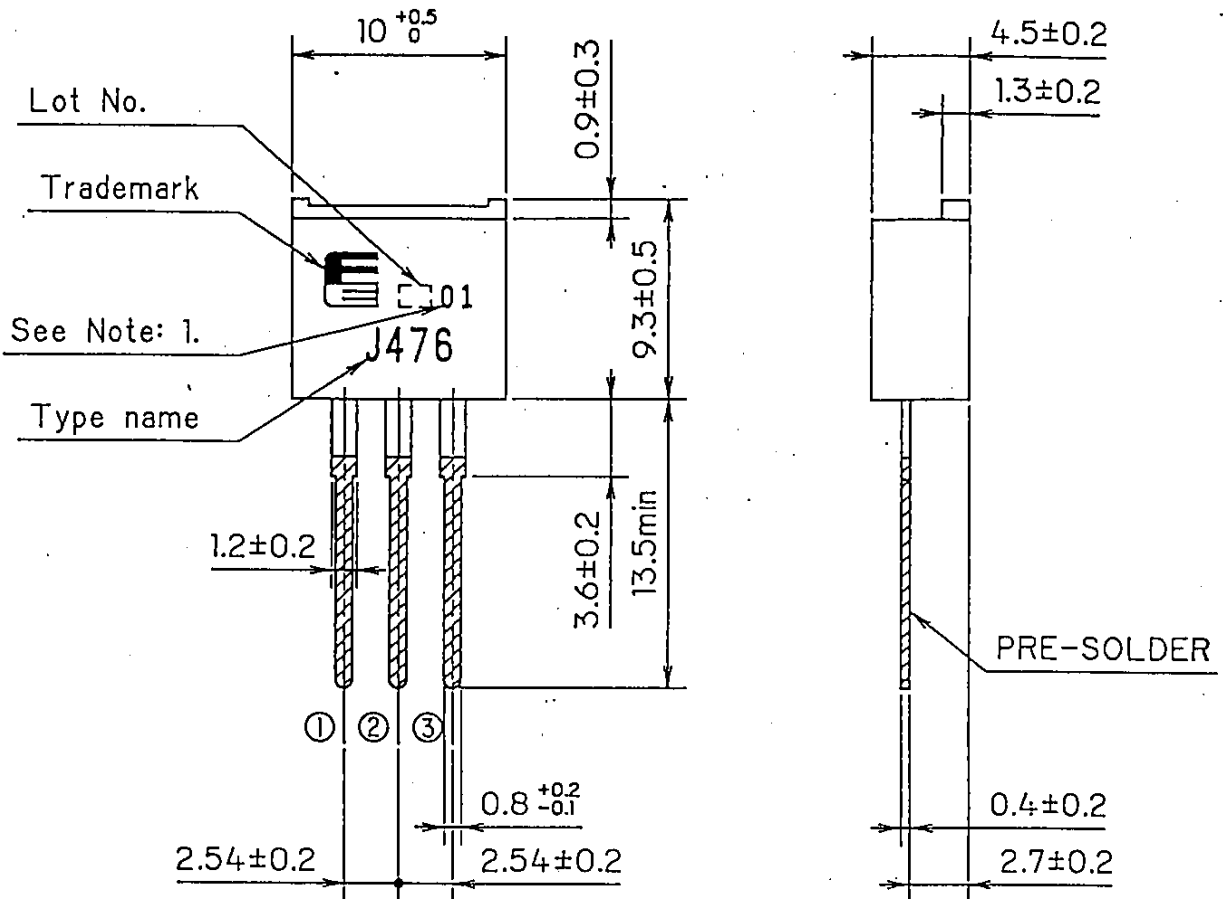


Fig.2 Operating waveforms



FUJI POWER MOS FET

TYPE : 2SJ476-01L



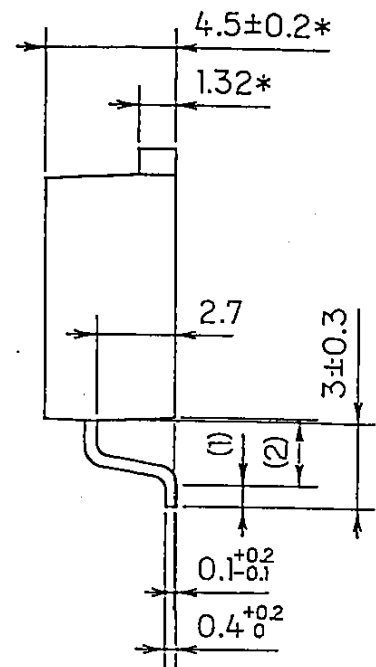
CONNECTION

- ① GATE
- ② DRAIN
- ③ SOURCE

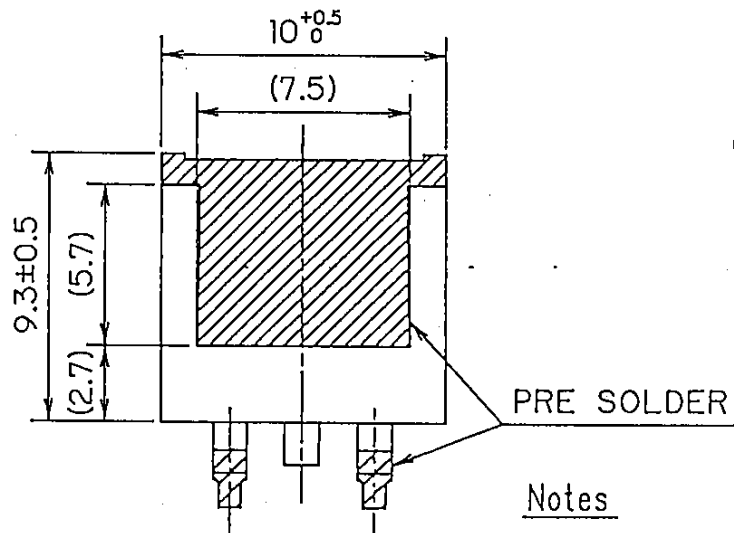
Note: 1. Guaranteed mark of avalanche ruggedness.

DIMENSIONS ARE IN MILLIMETERS.

TYPE : 2SJ476-01S



BOTTOM VIEW



CONNECTION

- ① GATE
④ ② DRAIN
③ SOURCE

Notes

1. () : REFERENCE DIMENSIONS.
2. * : DO NOT INCLUDE SOLDER.

Note 1. Guaranteed mark of
avalanche ruggedness.

DIMENSIONS ARE IN MILLIMETERS.

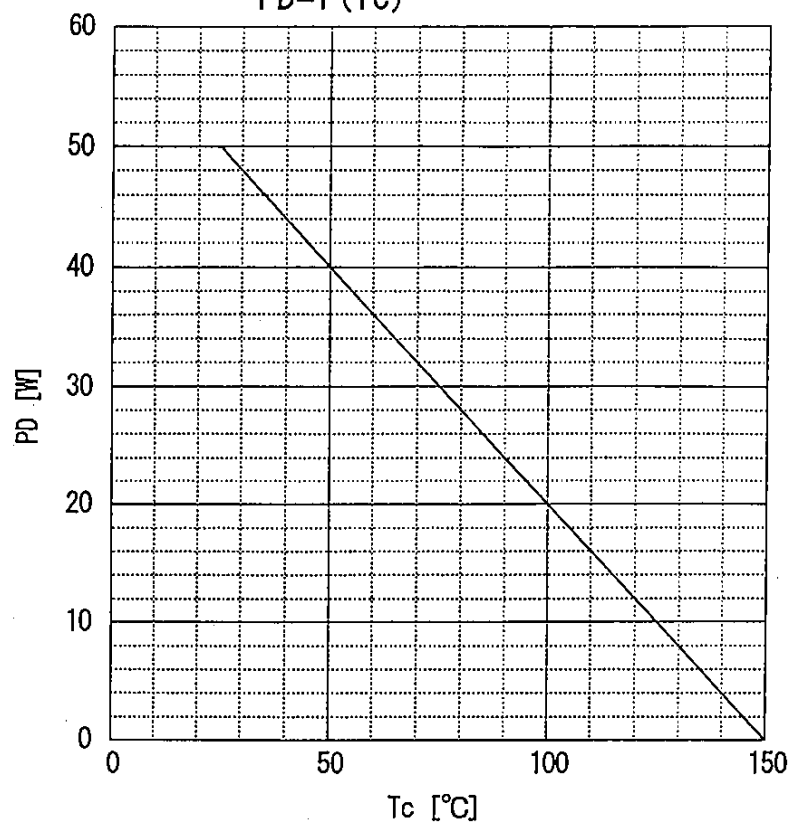
Fuji Electric Co., Ltd.

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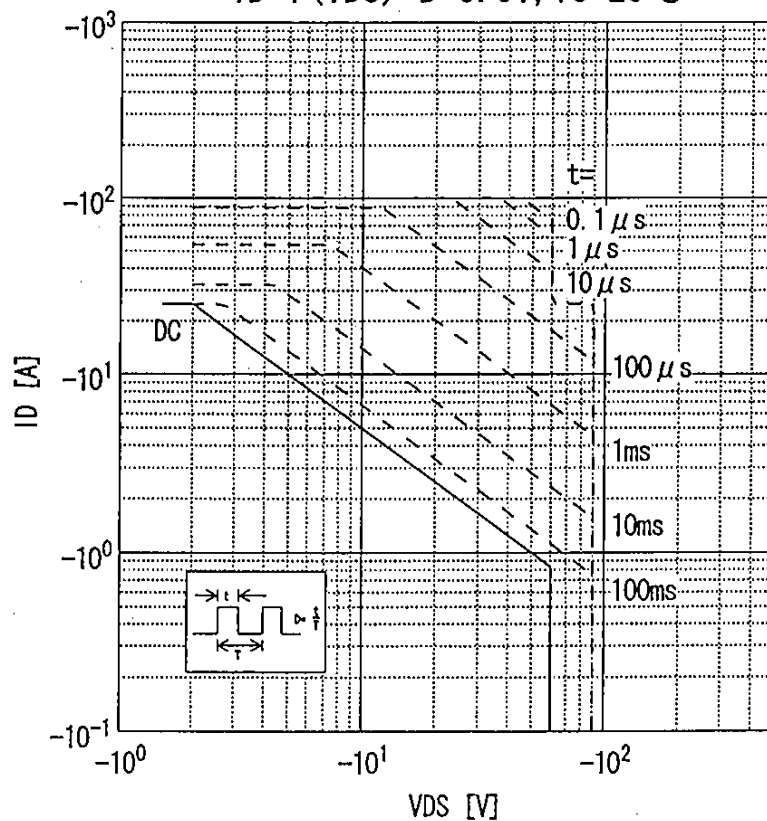
Power Dissipation

$$PD=f(T_c)$$

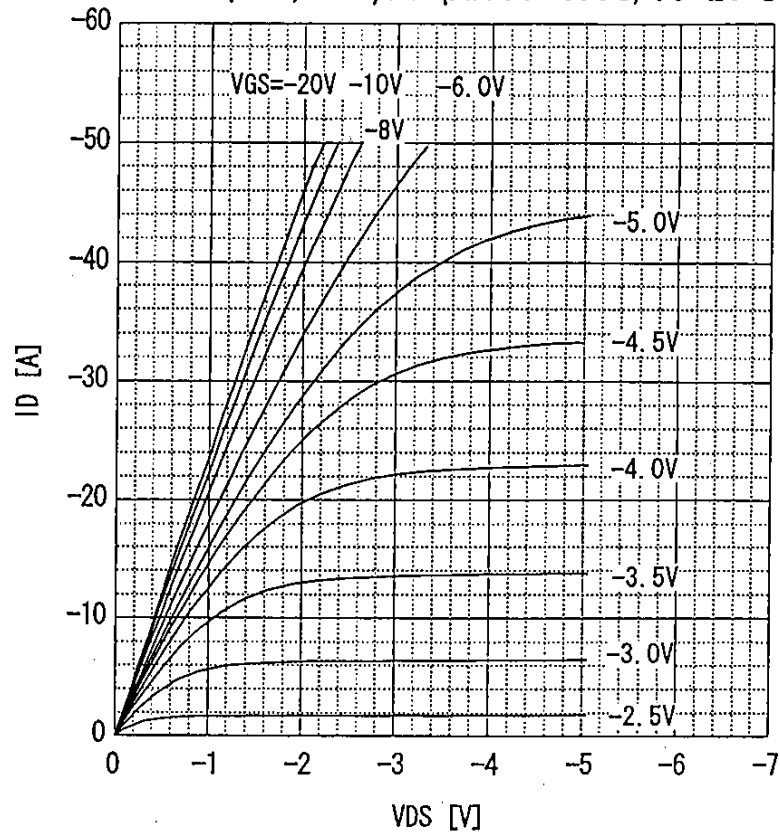


Safe operating area

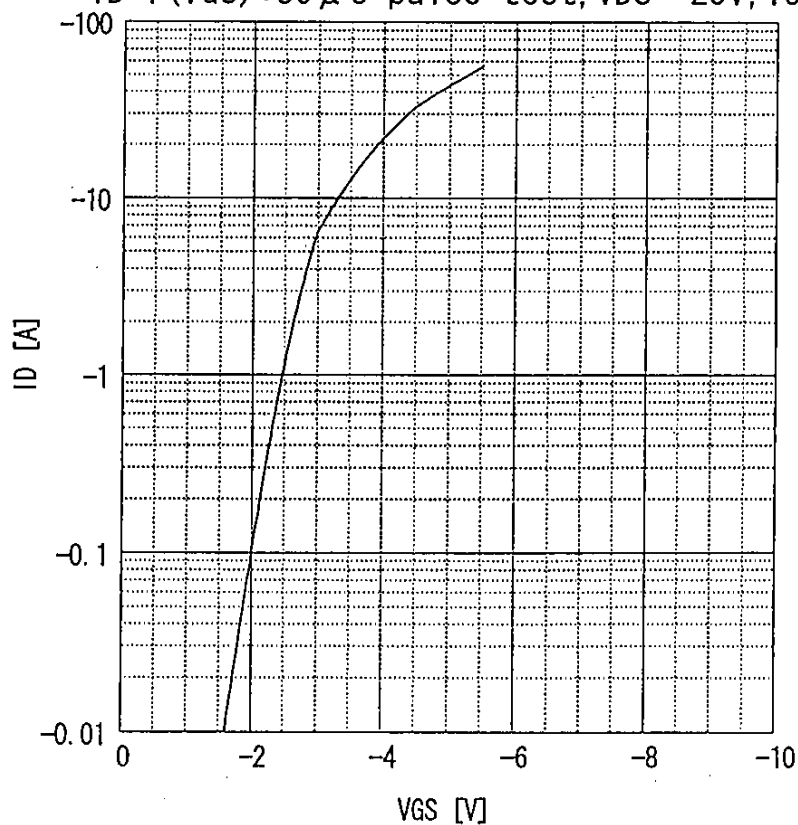
$$ID=f(V_{DS}): D=0.01, T_c=25^{\circ}C$$



Typical output characteristics
 $I_D = f(V_{DS}) : 80 \mu s \text{ pulse test, } T_c = 25^\circ C$

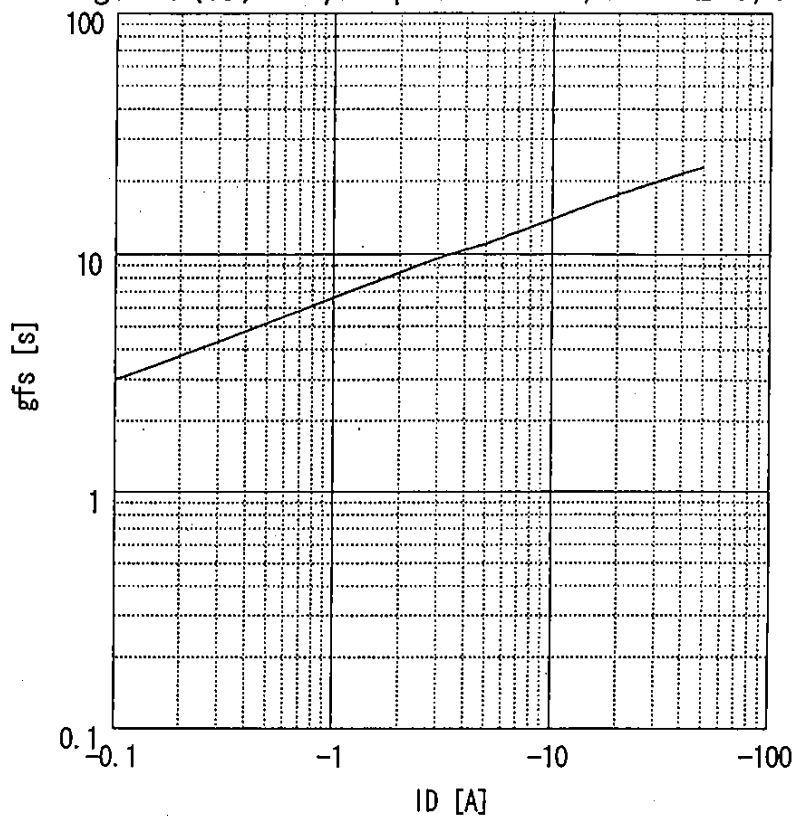


Typical transfer characteristic
 $I_D = f(V_{GS}) : 80 \mu s \text{ pulse test, } V_{DS} = -25V, T_{ch} = 25^\circ C$



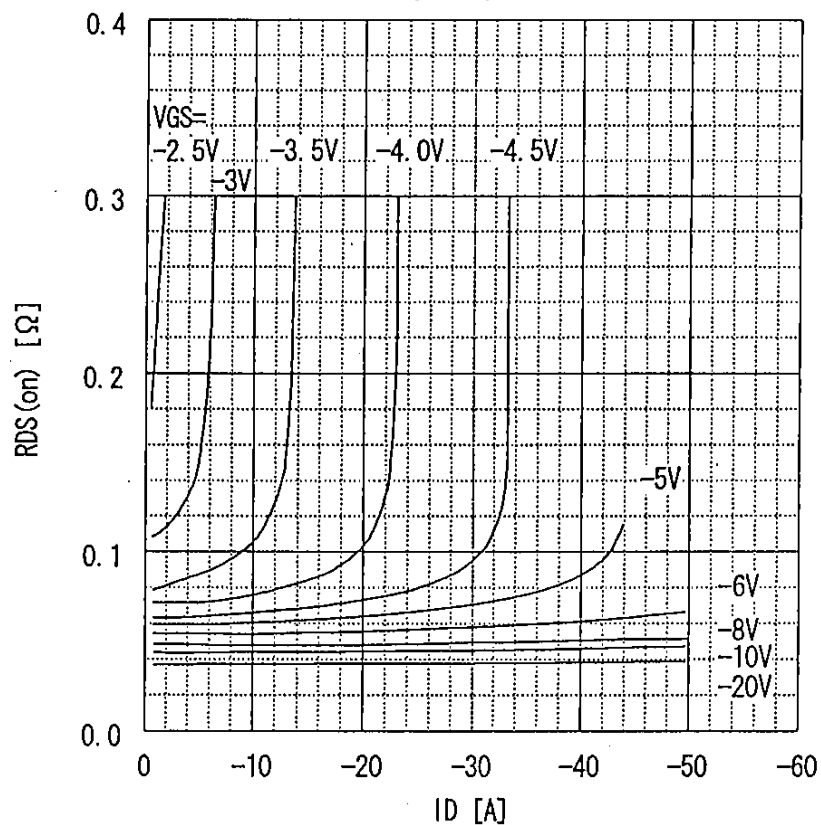
Typical forward transconductance

$g_{fs}=f(I_D)$: 80 μ s pulse test, $V_{DS}=-25V$, $T_{ch}=25^{\circ}C$

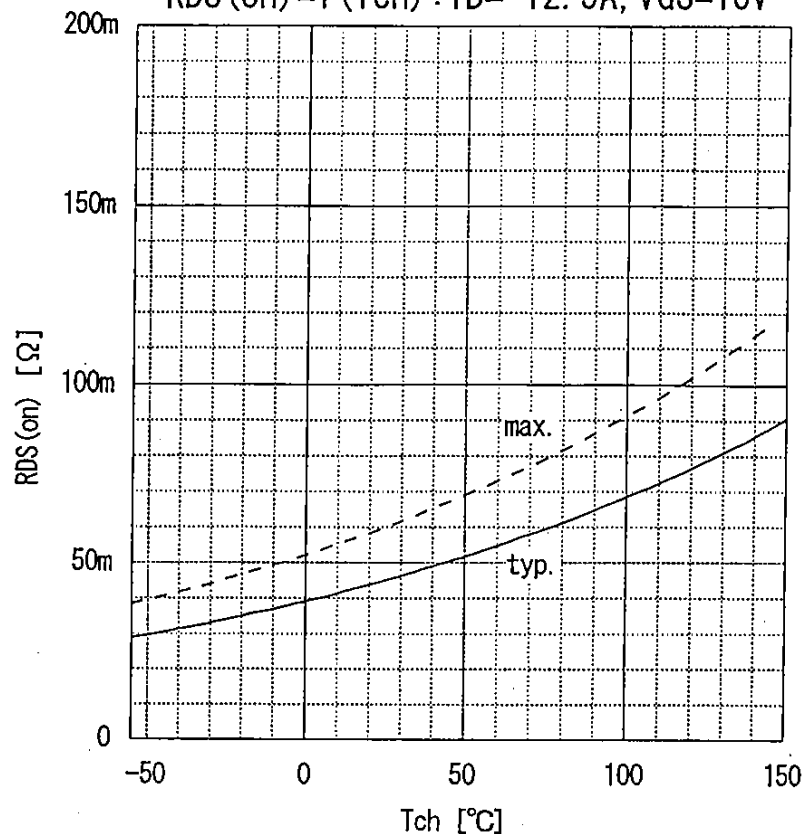


Typical drain-source on-state resistance

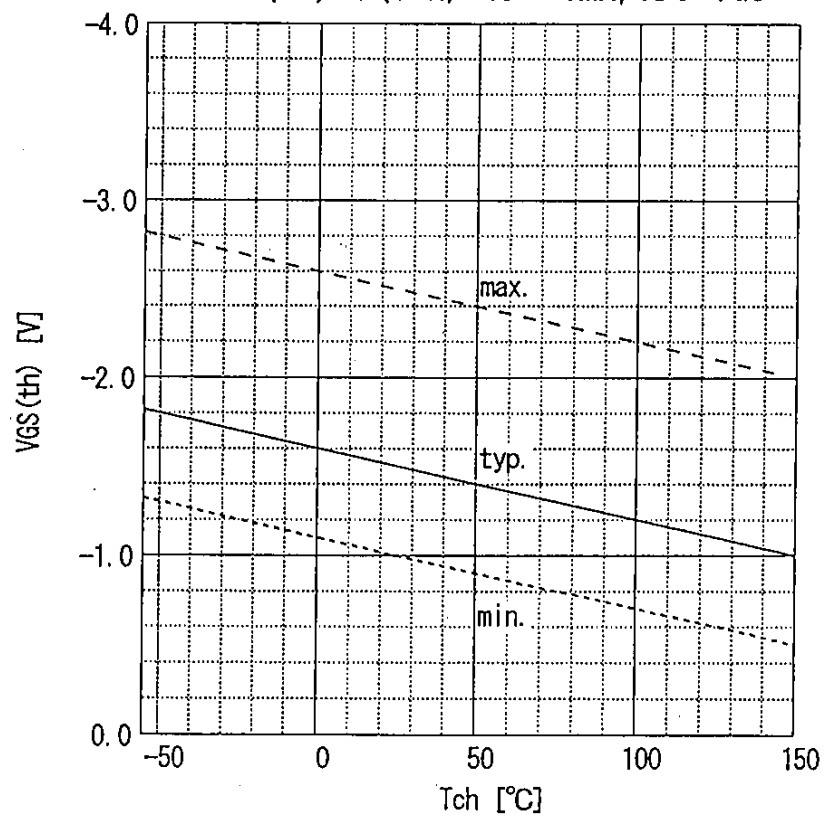
$R_{DS(on)}=f(I_D)$: 80 μ s pulse test, $T_c=25^{\circ}C$



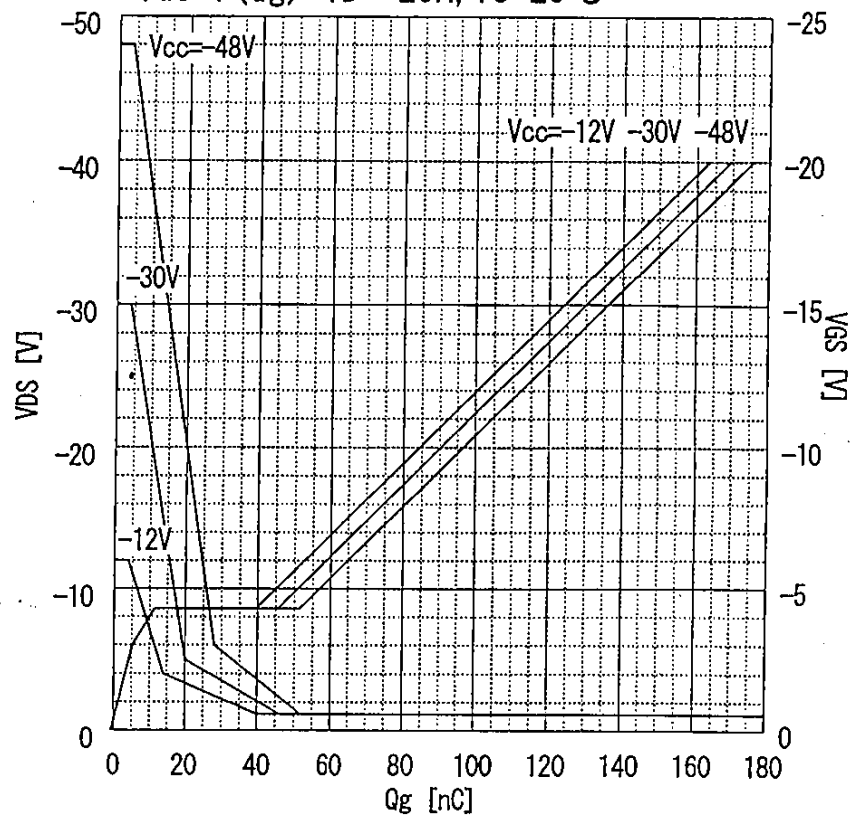
Drain-source on-state resistance
 $R_{DS(on)} = f(T_{ch}) : I_D = -12.5A, V_{GS} = 10V$



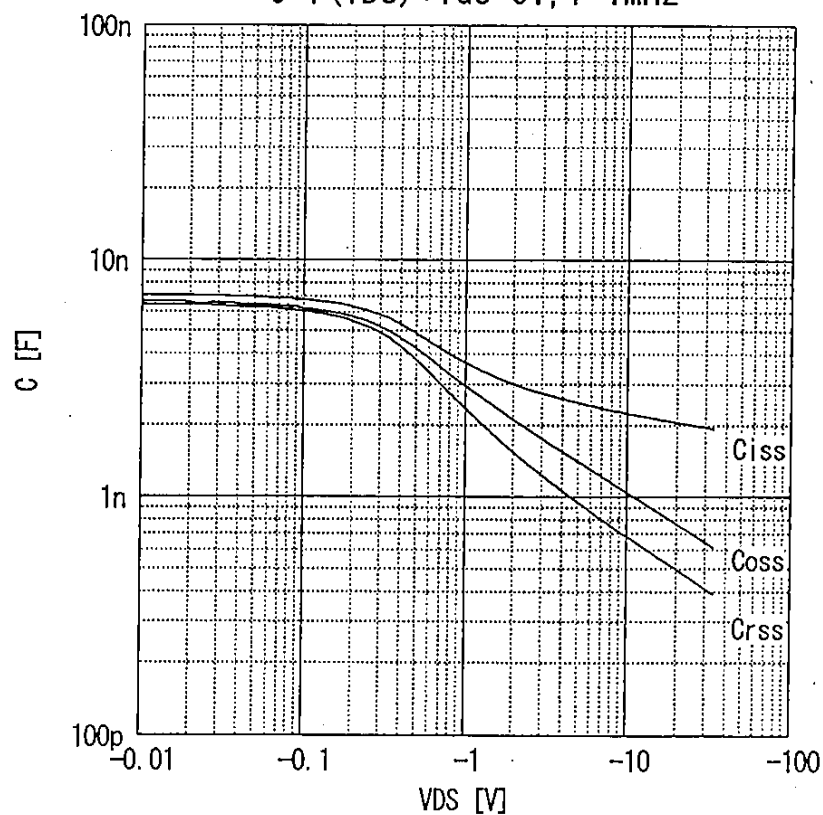
Gate threshold voltage
 $V_{GS(th)} = f(T_{ch}) : I_D = -1mA, V_{DS} = V_{GS}$



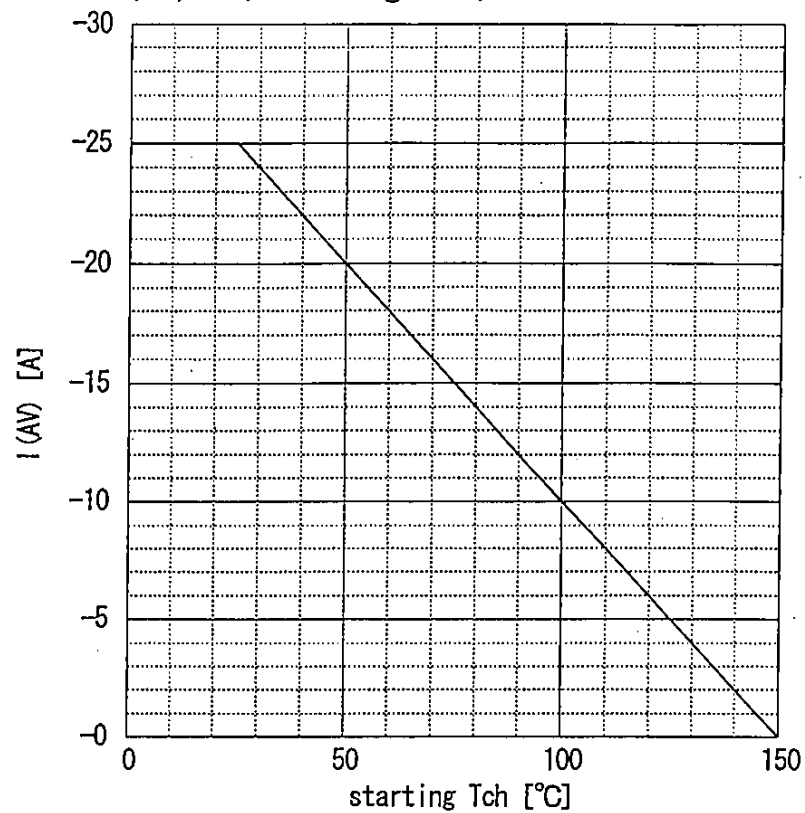
Typical gate charge characteristic
 $V_{GS}=f(Q_g) : I_D=-25A, T_c=25^{\circ}C$



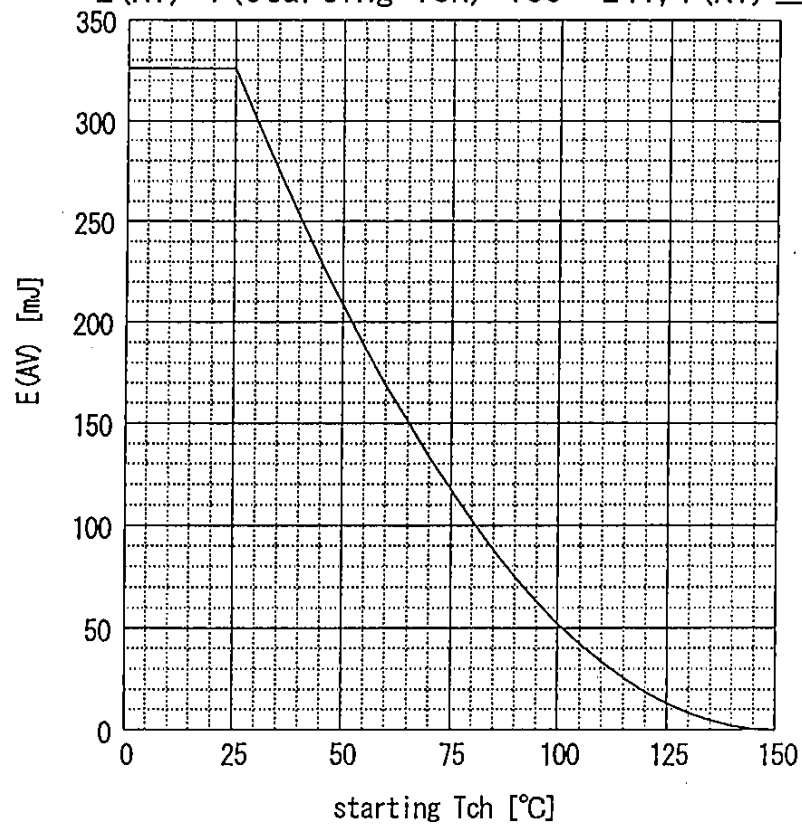
Typical capacitances
 $C=f(V_{DS}) : V_{GS}=0V, f=1MHz$



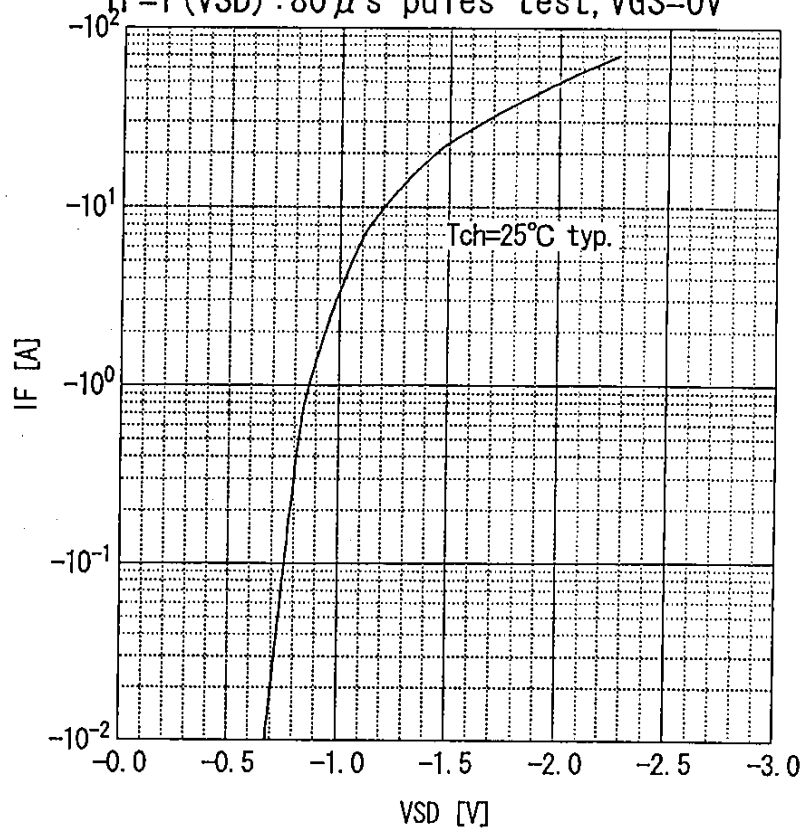
Maximum Avalanche Current vs. starting Tch
 $I(AV)=f(\text{starting Tch})$



Maximum Avalanche Energy vs. starting Tch
 $E(AV)=f(\text{starting Tch}) : V_{CC}=-24V, I(AV) \geq -25A$



Forward characteristic of reverse of diode
 $I_F = f(V_{SD}) : 80 \mu s$ pulses test, $V_{GS} = 0V$



Transient thermal impedance
 $Z_{thch} = f(t)$ parameter: $D = t/T$

